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March 2015

FDD86110

N-Channel Shielded Gate PowerTrench[®] MOSFET 100 V, 50 A, 10.2 m Ω

Features

- Shielded Gate MOSFET Technology
- Max $r_{DS(on)} = 10.2 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 12.5 \text{ A}$
- Max $r_{DS(on)} = 16 \text{ m}\Omega$ at $V_{GS} = 6 \text{ V}$, $I_D = 9.8 \text{ A}$
- 100% UIL tested
- RoHS Compliant

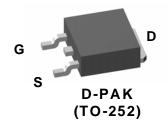


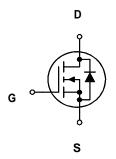
General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench® process that incorporates Shielded Gate technology. This process has been optimized for the on-state resistance and yet maintain superior switching performance.

Application

■ DC - DC Conversion





MOSFET Maximum Ratings T_C = 25 °C unless otherwise noted

Symbol	Paramet		Ratings	Units		
V _{DS}	Drain to Source Voltage			100	V	
V_{GS}	Gate to Source Voltage			±20	V	
	Drain Current -Continuous	T _C = 25 °C		50		
I_D	-Continuous	T _A = 25 °C	(Note 1a)	12.5	Α	
	-Pulsed		(Note 4)	150		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	135	mJ	
P _D	Power Dissipation	T _C = 25 °C		127	W	
	Power Dissipation $T_A = 25 ^{\circ}\text{C}$ (Note 1a)			3.1		
T _J , T _{STG}	Operating and Storage Junction Temperatu	ıre Range		-55 to +150	°C	

Thermal Characteristics

R_{ϵ}	ÐJC	Thermal Resistance, Junction to Case	0.98	°C/W
R_{ϵ}	θЈΑ	Thermal Resistance, Junction to Ambient (Note 1a)	40	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD86110	FDD86110	D-PAK(TO-252)	13 "	16 mm	2500 units

Electrical Characteristics $T_J = 25 \, ^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter Test Conditions		Min	Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	100			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	I_D = 250 μ A, referenced to 25 °C		72		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 80 V, V _{GS} = 0 V			1	μΑ
I_{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA

On Characteristics

V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	2	2.8	4	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 250 μ A, referenced to 25 °C		-10		mV/°C
		$V_{GS} = 10 \text{ V}, I_D = 12.5 \text{ A}$		8.5	10.2	
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 6 \text{ V}, I_D = 9.8 \text{ A}$		11.3	16	mΩ
		$V_{GS} = 10 \text{ V}, I_D = 12.5 \text{ A}, T_J = 125 ^{\circ}\text{C}$		15	18	
g _{FS}	Forward Transconductance	V _{DS} = 10 V, I _D = 12.5 A		38		S

Dynamic Characteristics

C _{iss}	Input Capacitance	V _{DS} = 50 V, V _{GS} = 0 V, f = 1MHz		1702	2265	pF
C _{oss}	Output Capacitance			379	505	pF
C _{rss}	Reverse Transfer Capacitance			17	30	pF
R_g	Gate Resistance		0.1	0.5	1.5	Ω

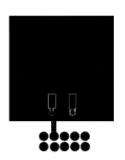
Switching Characteristics

t _{d(on)}	Turn-On Delay Time		12	20	ns
t _r	Rise Time	V _{DD} = 50 V, I _D = 12.5 A,	5.4	10	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$	19	35	ns
t _f	Fall Time		3.9	10	ns
Q_g	Total Gate Charge	$V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{DD} = 50 \text{ V},$ $I_D = 12.5 \text{ A}$	25	35	nC
Q _{gs}	Gate to Source Charge	$V_{DD} = 50 \text{ V},$ $I_{-} = 12.5 \text{ A}$	7.1		nC
Q_{gd}	Gate to Drain "Miller" Charge	ID = 12.0 A	5.2		nC

Drain-Source Diode Characteristics

V _{SD}	Source-Drain Dioge Forward Voltage	$V_{GS} = 0 \text{ V}, I_S = 12.5 \text{ A}$ (Note 2)	0.80	1.3	V
		$V_{GS} = 0 \text{ V}, I_{S} = 2.6 \text{ A}$ (Note 2)	0.72	1.2	
t _{rr}	Reverse Recovery Time	I _F = 12.5 A, di/dt = 100 A/μs	52	83	ns
Q _{rr}	Reverse Recovery Charge	1F = 12.5 A, αι/αι = 100 A/μS	60	96	nC

^{1.} R_{B,JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{B,JC} is guaranteed by design while R_{B,JA} is determined by the user's board design.



a) 40 °C/W when mounted on a 1 in² pad of 2 oz copper



b) 96 °C/W when mounted on a minimum pad

- Pulse Test: Pulse Width < 300 μs, Duty cycle < 2.0%.
 Starting T_J = 25 °C, L = 0.3 mH, I_{AS} = 30 A, V_{DD} = 90 V, V_{GS} = 10 V. 100% test at L = 0.1 mH, I_{AS} = 48 A.
 Pulsed Drain current is tested at 300 μs with 2% duty cycle. For repetitive pulses, the pulse width is limited by the maximum junction temperature.

Typical Characteristics T_J = 25 °C unless otherwise noted

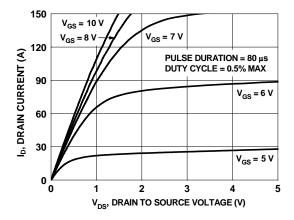


Figure 1. On Region Characteristics

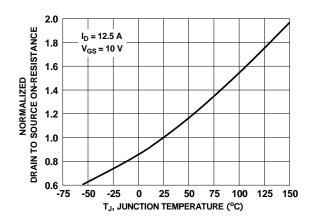


Figure 3. Normalized On Resistance vs Junction Temperature

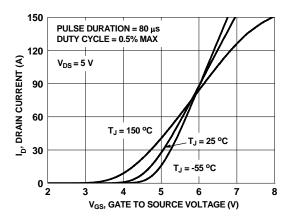


Figure 5. Transfer Characteristics

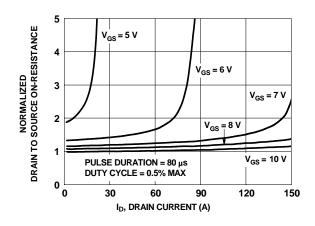


Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage

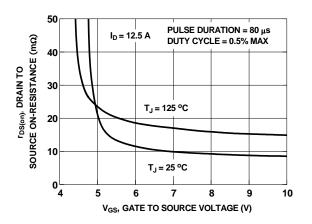


Figure 4. On-Resistance vs Gate to Source Voltage

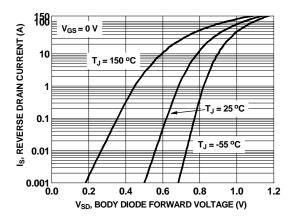


Figure 6. Source to Drain Diode Forward Voltage vs Source Current

Typical Characteristics $T_J = 25$ °C unless otherwise noted

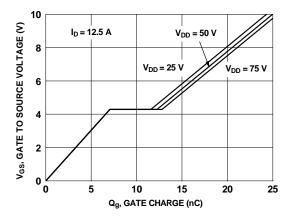


Figure 7. Gate Charge Characteristics

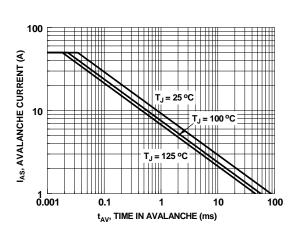


Figure 9. Unclamped Inductive Switching Capability

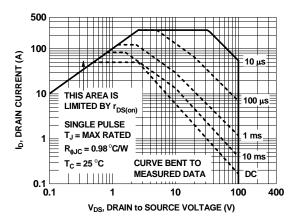


Figure 11. Forward Bias Safe Operating Area

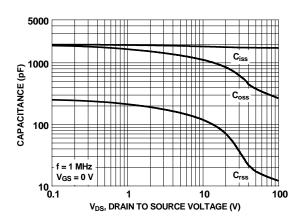


Figure 8. Capacitance vs Drain to Source Voltage

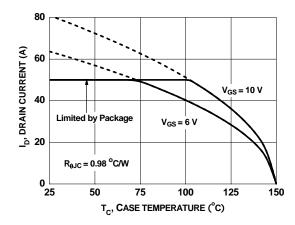


Figure 10. Maximum Continous Drain Current vs. Case Temperature

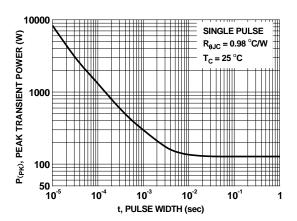


Figure 12. Single Pulse Maximum Power Dissipation

Typical Characteristics $T_J = 25$ °C unless otherwise noted

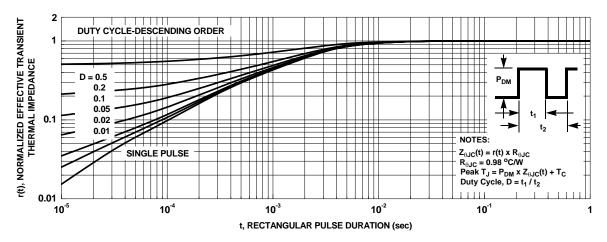
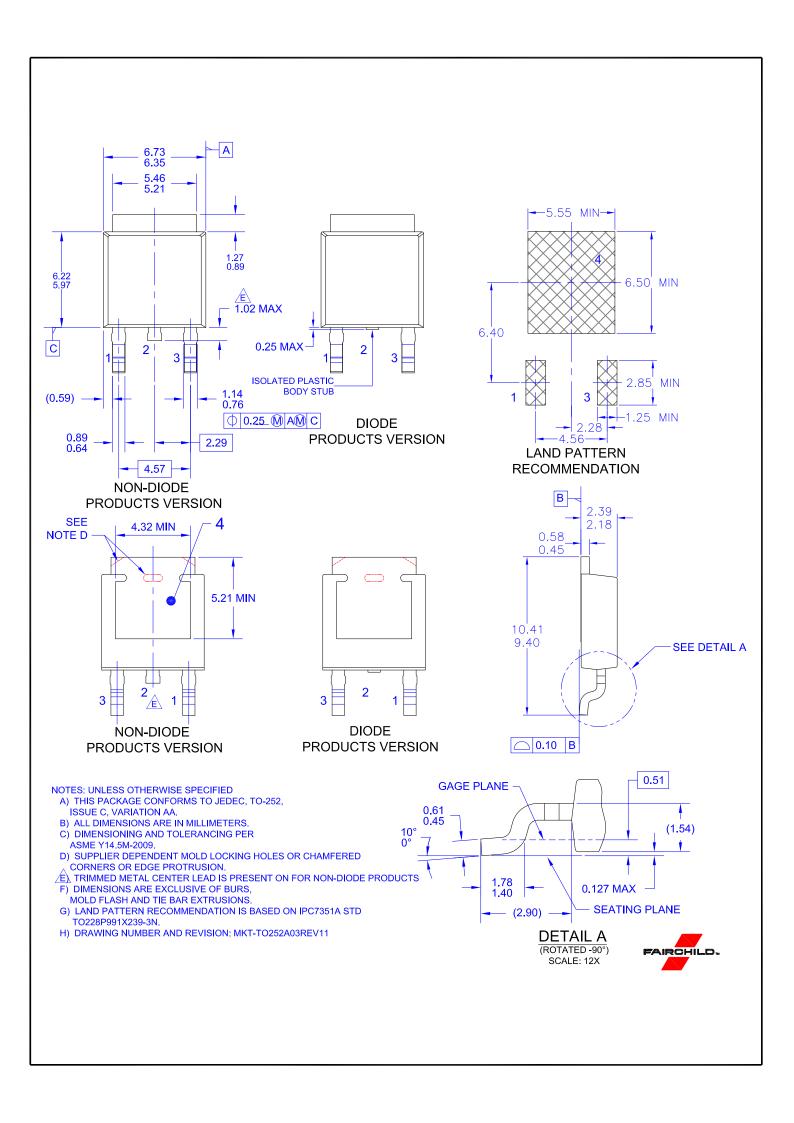


Figure 13. Junction-to-Case Transient Thermal Response Curve



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